



SG6846B

Highly Integrated Green-Mode PWM Controller

Features

- Low Startup Current: 8 μ A
- Low Operating Current: 3.7mA
- Peak-Current Mode Operation with Cycle-by-cycle Current Limiting
- PWM Frequency Continuously Decreasing with Burst Mode at Light Loads
- V_{DD} Over Voltage Protection (OVP)
- AC Input Brownout Protection with Hysteresis
- Constant Output Power Limit (Full AC Input Range)
- Internal Latch Circuit for OVP, OTP, and OCP (BLSY, BLSZ)
- Two-level OCP Delay with 200ms
- Programmable PWM Frequency with Frequency Hopping
- OCP Threshold is 2/3 Peak Current Limit
- Soft Startup Time: 5ms

Applications

General-purpose switch-mode power supplies and flyback power converters, including:

- Power Adapters
- Open-frame SMPS
- SMPS with Surge-current Output, such as for Printers, Scanners, Motor Drivers

Description

The highly integrated PWM controller, SG6846B, provides several features to enhance the performance of fly-back converters. To minimize standby power consumption, a proprietary green-mode function provides off-time modulation to continuously decrease the switching frequency under light-load conditions. Under zero-load conditions, the power supply enters burst-mode. This completely shuts off PWM output. If V_{FB} is larger than around 1.6V, PWM pulses out. This green-mode function enables power supplies to meet international power conservation requirements.

The SG6846B is designed for SMPS with surge-current output. It is incorporated with a two-level OCP function. Besides, the cycle-by-cycle current limiting, if the switching current is higher than OCP threshold and lasts for 200ms, SG6846B stops gate immediately and latches itself (BLSY version) or restarts after V_{DD} charges up to 16.5V (BCSY version). SG6846B also integrates frequency-hopping function internally. The frequency hopping function helps reduce EMI emission of a power supply with minimum line filters. It has built-in synchronized slope compensation, proprietary internal compensation for constant output power limit over universal AC input range. The gate output is clamped at 18V to protect the external MOSFET from over-voltage damage.

Protection include: AC input brownout protection with hysteresis and V_{DD} over-voltage protection. For over-temperature protection, an external NTC thermistor can be applied to sense the ambient temperature. When OCP, V_{DD} OVP, or OTP are activated, an internal latch circuit is used to latch-off the controller. The latch resets when V_{DD} supply is removed.

SG6846B is available in 8-pin SOP package.

Ordering Information

| Part Number | Operating Temperature Range | OCP Latch | Eco Status | Package | Packing Method |
|-------------|-----------------------------|-----------|------------|-----------------------------------|----------------|
| SG6846BLSY | -40 to +105°C | Yes | Green | 8-Pin Small Outline Package (SOP) | Tape & Reel |
| SG6846BLSZ | -40 to +105°C | Yes | RoHS | 8-Pin Small Outline Package (SOP) | Tape & Reel |
| SG6846BCSY | -40 to +105°C | No | Green | 8-Pin Small Outline Package (SOP) | Tape & Reel |
| SG6846BCSZ | -40 to +105°C | No | RoHS | 8-Pin Small Outline Package (SOP) | Tape & Reel |

For Fairchild's definition of "green" Eco Status, please visit: http://www.fairchildsemi.com/company/green/rohs_green.html.

Typical Application

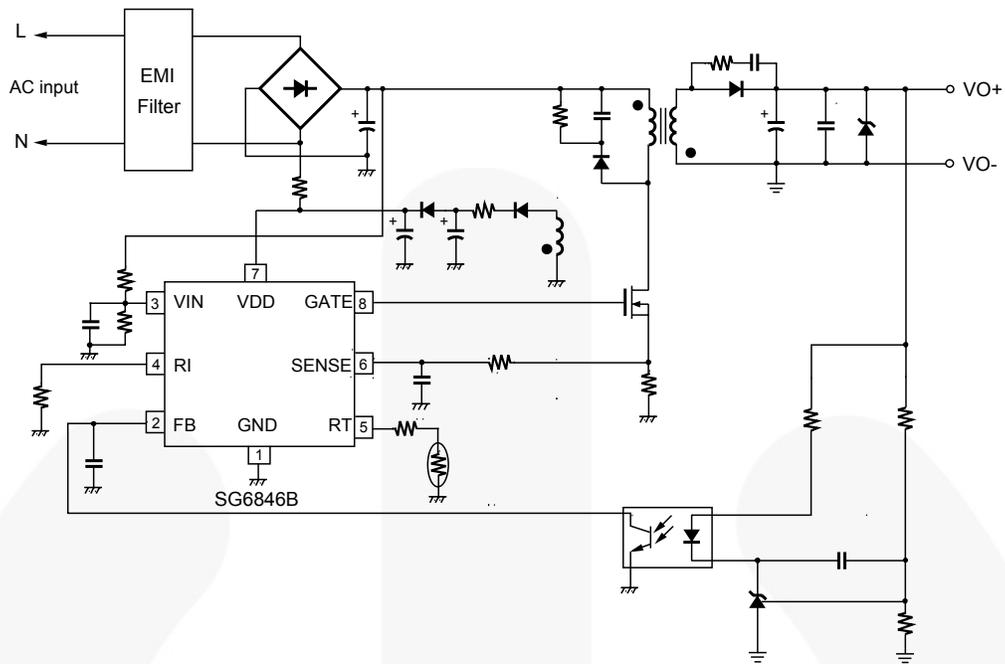


Figure 1. Typical Application

Block Diagram

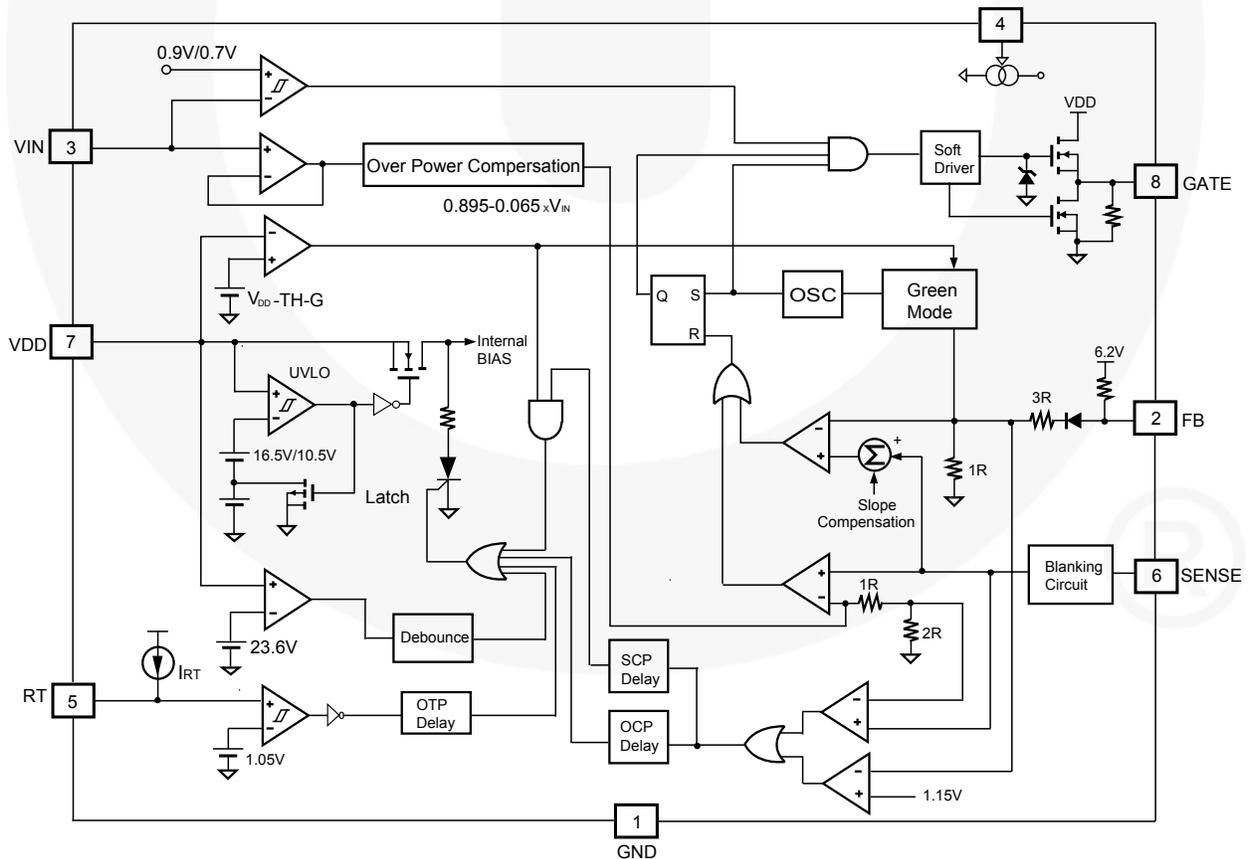
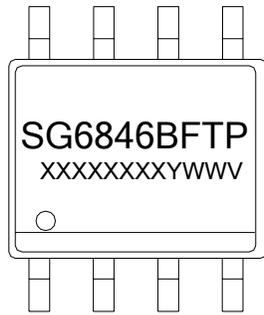


Figure 2. Block Diagram

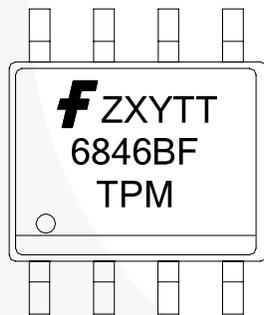
Marking Information



F: L = OCP Latch, C = OCP auto-recovery
T: S = SOP
P: Z = Lead Free + ROHS Compatible
 Null = regular package
XXXXXXXX: Wafer Lot
Y: Year; **WW**: Week
V: Assembly Location

※ Marking for SG6846BLSZ (Pb-free)
 SG6846BCSZ (Pb-free)

Figure 3. Top Mark 1



F: Fairchild logo
Z: Plant Code
X: Year Code
Y: Week Code
TT: Die Run Code
F: L = OCP Latch, C = OCP auto-recovery
T: Package type, S = SOP
P: Y = Green Package
M: Manufacturing flow code

※ Marking for SG6846BLSY (Green-compound)
 SG6846BCSY (Green-compound)

Figure 4. Top Mark 2

Pin Configuration

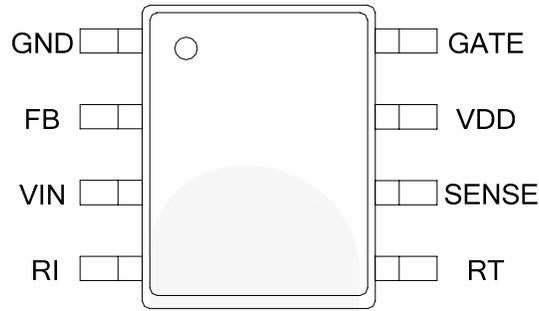


Figure 5. Pin Configuration

Pin Definitions

| Pin # | Name | Function | Description |
|-------|-------|------------------------|---|
| 1 | GND | Ground | Ground. |
| 2 | FB | Feedback | The signal from the external compensation circuit is fed into this pin. The PWM duty cycle is determined in response to the signal from this pin and the current-sense signal from pin 6. |
| 3 | VIN | Line-voltage Detection | Line-voltage detection is used for brownout protection with hysteresis. Constant output power limit over universal AC input range is achieved using this pin. Add a low-pass filter to filter out line ripple on the bulk capacitor. |
| 4 | RI | Reference Setting | A resistor from the RI pin to ground generates a reference current source that determines the switching frequency. Increasing the resistance reduces the switching frequency. A 26kΩ resistor results in a 65kHz switching frequency. |
| 5 | RT | Temperature Detection | For over-temperature protection, an external NTC thermistor is connected from this pin to the GND pin. The impedance of the NTC decreases at high temperatures. Once the voltage of the RT pin drops below a threshold, PWM output is disabled. |
| 6 | SENSE | Current Sense | The sensed voltage is used for peak-current-mode control and cycle-by-cycle current limiting. If the switching current is higher than OCP threshold and lasts for 200ms, SG6846B turns off immediately. This two-level OCP feature is especially suitable for SMPS with surge current output. |
| 7 | VDD | Power Supply | If an open-circuit failure occurs in the feedback loop, the internal protection circuit disables PWM output as long as V _{DD} exceeds a threshold. |
| 8 | GATE | Driver Output | The totem-pole output driver for the power MOSFET; internally clamped below 18V. |

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. All voltage values, except differential voltages, are given with respect to GND pin.

| Symbol | Parameter | Min. | Max. | Unit |
|------------------|--|------|------|------|
| V _{DD} | Supply Voltage | | 30 | V |
| V _L | Input Voltage to FB, SENSE, VIN, RT, RI Pins | -0.3 | 7.0 | V |
| P _D | Power Dissipation at T _A <50°C | | 400 | mW |
| Θ _{JC} | Thermal Resistance (Junction-to-Case) | | 54.4 | °C/W |
| T _J | Operating Junction Temperature | -40 | +150 | °C |
| T _{STG} | Storage Temperature Range | -65 | +150 | °C |
| T _L | Lead Temperature, Wave Soldering, 10 Seconds | | +260 | °C |
| ESD | Human Body Model, JESD22-A114 | | 5.0 | kV |
| | Charge Device Model, JESD22-C101 | | 1.5 | |

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

| Symbol | Parameter | Min. | Max. | Unit |
|----------------|-------------------------------|------|------|------|
| T _A | Operating Ambient Temperature | -40 | +105 | °C |

Electrical Characteristics

$V_{DD} = 15V$ and $T_A = 25^\circ C$ unless otherwise noted.

| Symbol | Parameter | Test Condition | Min. | Typ. | Max. | Unit |
|-------------------------------|---|--|---------------------------|---------------------------|---------------------------|------|
| V_{DD} Section | | | | | | |
| V _{DD-OP} | Continuously Operating Voltage | | | | 20 | V |
| V _{DD-ON} | Turn-on Threshold Voltage | | 15.5 | 16.5 | 17.5 | V |
| V _{DD-OFF} | Turn-off Voltage | | 9.5 | 10.5 | 11.5 | V |
| V _{DD-SCP} | Threshold Voltage on V _{DD} for Short-Circuit Protection | | V _{DD-OFF} +0.5V | V _{DD-OFF} +1.0V | V _{DD-OFF} +1.5V | V |
| V _{DD-LH} | Threshold Voltage for Latch-off Release | | 3 | 4 | 5 | V |
| I _{DD-ST} | Startup Current | V _{DD-ON} – 0.16V | | 8 | 30 | μA |
| I _{DD-OP} | Operating Supply Current | GATE Open | | 3.7 | 5.0 | mA |
| V _{DD-OVP} | V _{DD} Over-Voltage Protection (Latch off) | | 23 | 24 | 25 | V |
| t _{D-VDDOVP} | V _{DD} OVP Debounce Time | R _I = 26kΩ | | 150 | | μs |
| I _{DD-OVP} | V _{DD} OVP Latch-off Holding Current | V _{DD} = 5V | 30 | 50 | 70 | μA |
| V_{IN} Section | | | | | | |
| V _{IN-OFF} | PWM Turn-off Threshold Voltage | | 0.65 | 0.70 | 0.75 | V |
| V _{IN-ON} | PWM Turn-on Threshold Voltage | | V _{IN-OFF} +0.18 | V _{IN-OFF} +0.20 | V _{IN-OFF} +0.22 | V |
| Feedback Input Section | | | | | | |
| A _V | Input-Voltage to Current-Sense Attenuation | | 1/3.5 | 1/4.0 | 1/4.5 | V/V |
| Z _{FB} | Input Impedance | | 4.0 | 5.5 | 7.0 | kΩ |
| V _{FBO} | FB Pin Open Voltage | | 5.2 | 6.2 | 6.6 | V |
| Current Sense Section | | | | | | |
| Z _{SENSE} | Input Impedance | | | 12 | | kΩ |
| t _{PD} | Delay to Output | | | 100 | 250 | ns |
| t _{LEB} | Leading-edge Blanking Time | | 270 | 360 | | ns |
| V _{SLOPE} | Slope Compensation | Duty = DCY _{MAX} | 0.30 | 0.33 | 0.36 | V |
| V _{STH1V} | Threshold Voltage for Current Limit | V _{IN} = 1V | 0.80 | 0.83 | 0.86 | V |
| V _{STH3V} | Threshold Voltage for Current Limit | V _{IN} = 3V | 0.67 | 0.70 | 0.73 | V |
| V _{STH1V-2/3} | OCF Threshold Voltage for Current Limit | V _{IN} = 1V | 0.58 | 0.61 | 0.64 | V |
| V _{STH3V-2/3} | OCF Threshold Voltage for Current Limit | V _{IN} = 3V | 0.48 | 0.51 | 0.54 | V |
| t _{D-OCF} | Delay Time for Over-Current Protection | R _I = 26kΩ | 175 | 200 | 225 | ms |
| t _{D-Short} | Output Short Circuit Protection delay time | V _{CS} > V _{STH} , R _I = 26kΩ, V _{DD} < V _{DD-SCP} | 6 | 7 | 8 | ms |
| t _{SS-65KHz} | Period During Soft Start Time | R _I = 26kΩ | 4.5 | 5.0 | 5.5 | ms |
| t _{SS-130KHz} | | R _I = 13kΩ | 2.25 | 2.50 | 2.75 | ms |

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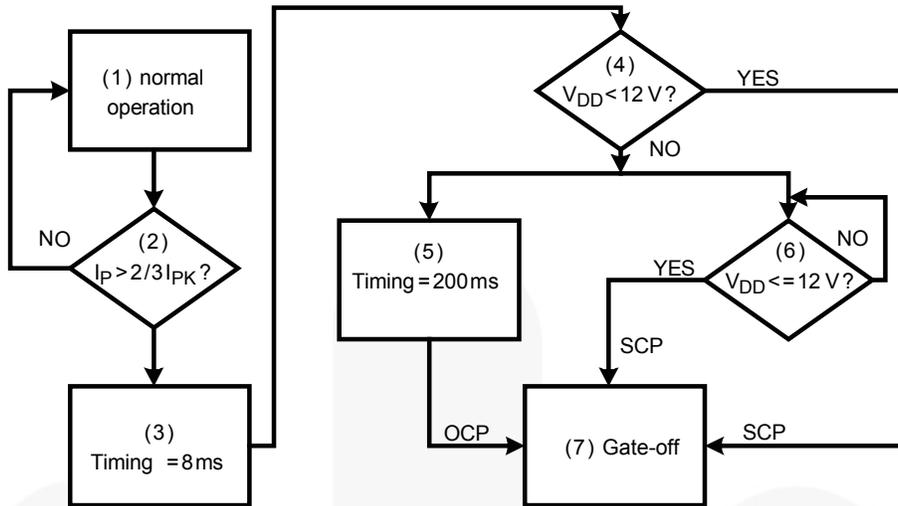


Figure 6. SG6846B OCP/SCP Logic Flow Diagram

Electrical Characteristics (Continued)

V_{DD} = 15V and T_A = 25°C unless otherwise noted.

| Symbol | Parameter | | Test Condition | Min. | Typ. | Max. | Unit |
|---------------------------|---|------------------|---|-------|-------|-------|-------|
| Oscillator Section | | | | | | | |
| f _{OSC} | Normal PWM Frequency | Center Frequency | R _I = 26kΩ, V _{FB} > V _N | 62 | 65 | 68 | kHz |
| | | Jitter Range | | ±3.7 | ±4.2 | ±4.7 | |
| f _{OSC,MAX} | Maximum PWM Frequency | Center Frequency | R _I = 13kΩ, V _{FB} > V _N | 124 | 130 | 136 | kHz |
| | | Jitter Range | | ±7.4 | ±8.4 | ±9.4 | |
| f _{OSC,MIN} | Minimum PWM Frequency | Center Frequency | R _I = 36kΩ, V _{FB} > V _N | 44.8 | 47.0 | 49.2 | kHz |
| | | Jitter Range | | ±2.54 | ±2.90 | ±3.26 | |
| t _{hop-1} | Jitter Period | | R _I = 26kΩ, V _{FB} ≥ V _N | 3.9 | 4.4 | 4.9 | ms |
| f _{OSC-G} | Green-Mode Minimum Frequency | | R _I = 26kΩ | 18.0 | 22.5 | 25.0 | kHz |
| S _G | Slope for Green-Mode Modulation | | R _I = 26kΩ | | 85 | | Hz/mV |
| V _{FB-N} | FB Pin Frequency Reduction Threshold | Pin, FB voltage | R _I = 26kΩ, V _{FB} = V _N | 1.9 | 2.1 | 2.3 | V |
| | | Jitter Range | | 3.7 | 4.2 | 4.7 | KHz |
| V _{FB-G} | FB Voltage at f _{OSC-G} | Pin, FB voltage | R _I = 26kΩ, V _{FB} = V _G | 1.4 | 1.6 | 1.8 | V |
| f _{DV} | Frequency Variation vs. V _{DD} Deviation | | V _{DD} = 11.5V to 20V | | | 5 | % |
| f _{DT} | Frequency Variation vs. Temperature Deviation | | T _A = -30 to 85°C | | 1.5 | 5.0 | % |

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Electrical Characteristics (Continued)

 $V_{DD} = 15V$ and $T_A = 25^\circ C$ unless otherwise noted.

| Symbol | Parameter | Test Condition | Min. | Typ. | Max. | Unit |
|--|---|---|------|------|------|------------|
| PWM Output Section | | | | | | |
| DCY_{MAX} | Maximum Duty Cycle | | 80 | 85 | 90 | % |
| V_{OL} | Output Voltage Low | $V_{DD} = 15V, I_O = 50mA$ | | | 1.5 | V |
| V_{OH} | Output Voltage High | $V_{DD} = 12V, I_O = 50mA$ | 8 | | | V |
| t_R | Rising Time | GATE = 1nF | | 350 | | ns |
| t_F | Falling Time | GATE = 1nF | | 50 | | ns |
| V_{CLAMP} | Gate Output Clamping Voltage | $V_{DD} = 20V$ | | | 18 | V |
| Over-Temperature Protection (OTP) Section⁽¹⁾ | | | | | | |
| I_{RT} | Output Current of RT Pin | $R_I = 26k\Omega$ | 64 | 70 | 76 | μA |
| V_{RTTH} | Threshold Voltage for OTP | | 1.00 | 1.05 | 1.10 | V |
| $t_{DOTP-LATCH}$ | Over-Temperature Latch-off Debounce | SG6846BLSY or SG6846BCSY, $R_I = 26k\Omega, V_{FB} > V_N$ | | 100 | | ms |
| | | SG6846BLSZ or SG6846BCSZ, $R_I = 26k\Omega, V_{FB} > V_N$ | | 100 | | μs |
| R_{RT-OFF} | Equivalent Impedance of RT for OTP ⁽¹⁾ | $R_I = 26k\Omega$ | 14 | 15 | 16 | k Ω |
| R_I Section | | | | | | |
| R_{I-NOR} | R_I Operating Range | | 13 | | 36 | k Ω |
| R_{I-MAX} | Maximum R_I Value for Protection | | 10 | | | M Ω |
| R_{I-MIN} | Minimum R_I Value for Protection | | | | 6 | k Ω |

Note:

- The relationship between R_{RT-OFF} and R_I is: $R_{RT-OFF} = V_{OTP-LATCH-OFF} / I_{RT} = V_{RT} / (70\mu A \times 26 / R_I (K\Omega))$ (1)

Typical Performance Characteristics

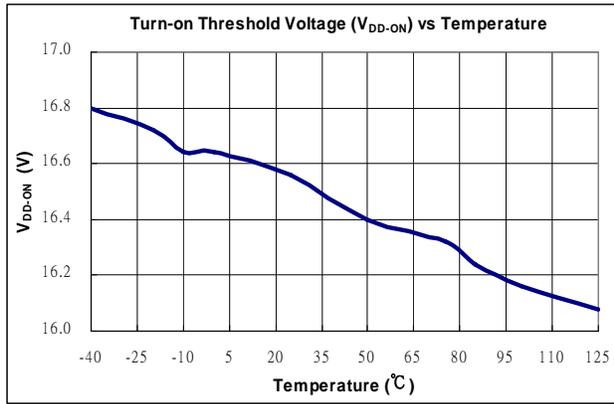


Figure 7. Turn-on Threshold Voltage (V_{DD-ON}) vs. Temperature

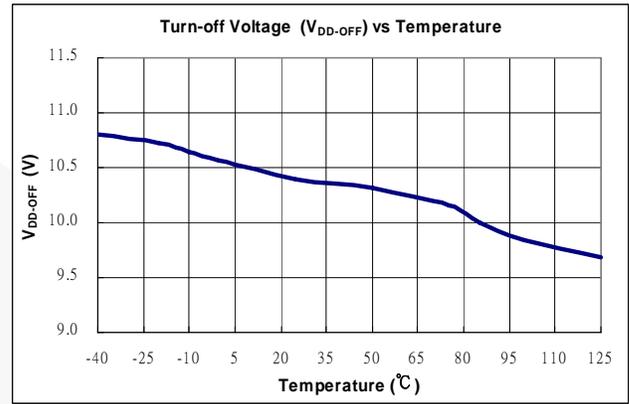


Figure 8. Turn-off Threshold Voltage (V_{DD-OFF}) vs. Temperature

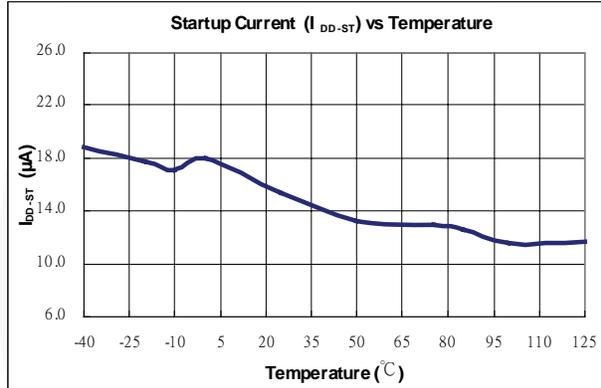


Figure 9. Startup Current (I_{DD-ST}) vs. Temperature

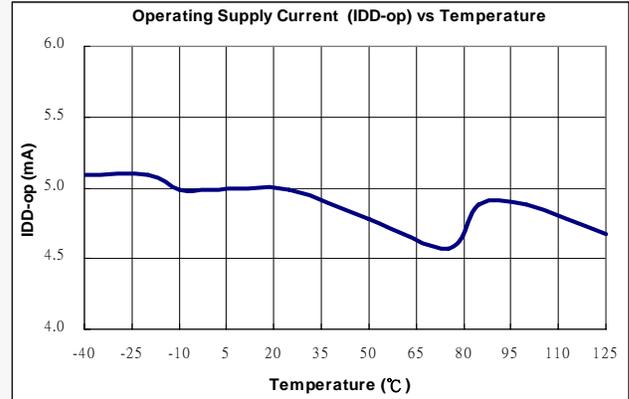


Figure 10. Operating Supply Current (I_{DD-OP}) vs. Temperature

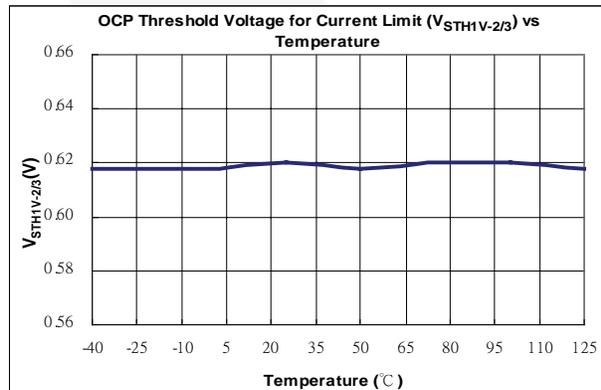


Figure 11. OCP Threshold Voltage for Current Limit ($V_{STH1V-2/3}$) vs. Temperature

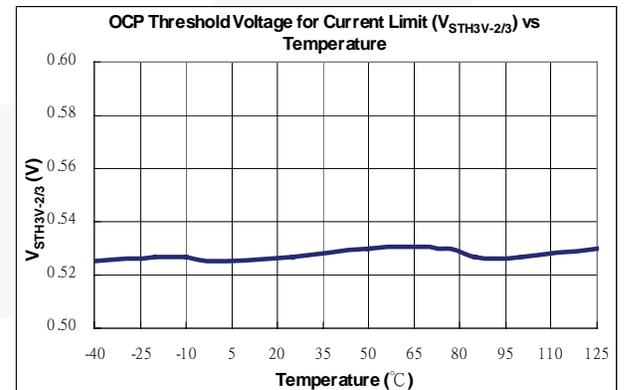


Figure 12. OCP Threshold Voltage for Current Limit ($V_{STH3V-2/3}$) vs. Temperature

Typical Performance Characteristics (Continued)

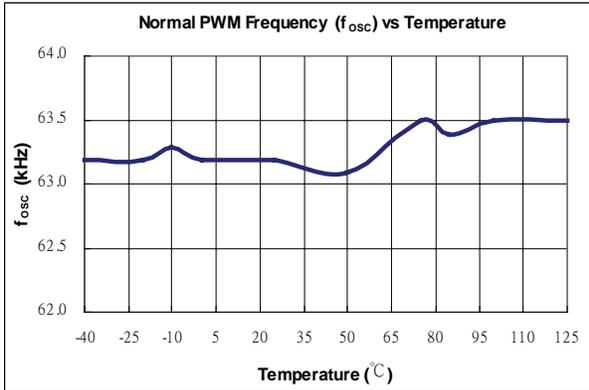


Figure 13. Normal PWM Frequency (f_{osc}) vs. Temperature

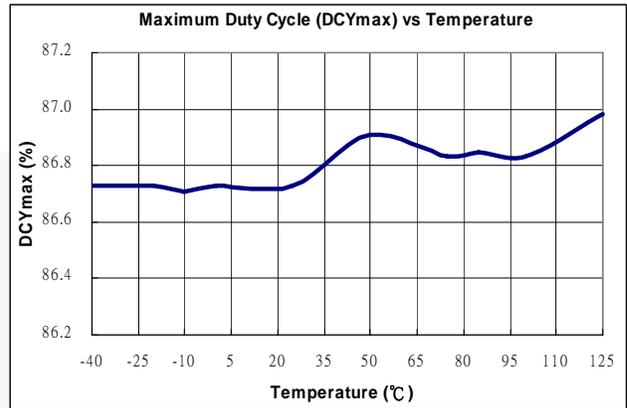


Figure 14. Maximum Duty Cycle (DCY_{max}) vs. Temperature

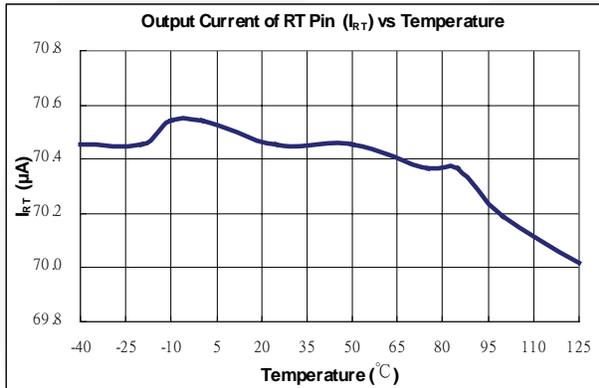


Figure 15. Output Current of RT pin (I_{RT}) vs. Temperature

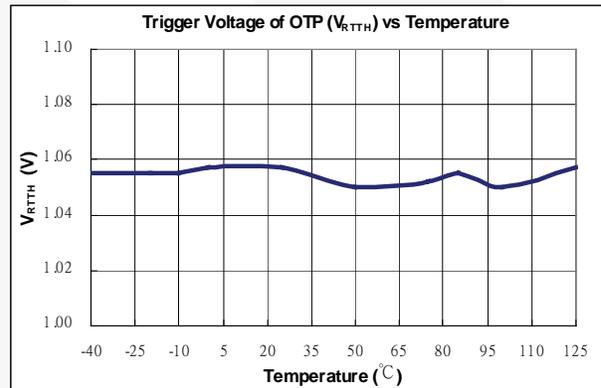


Figure 16. Trigger Voltage of OTP (V_{RTTH}) vs. Temperature

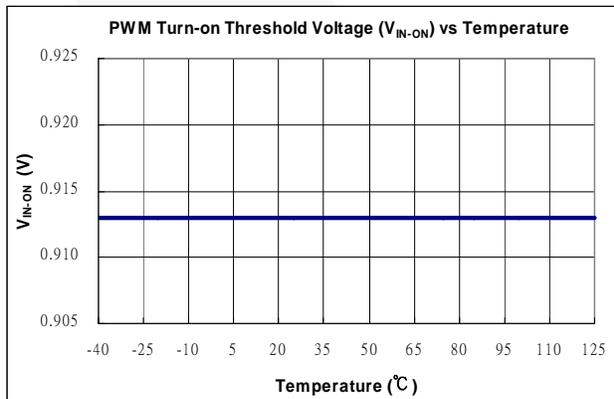


Figure 17. PWM Turn-on Threshold Voltage (V_{IN-ON}) vs. Temperature

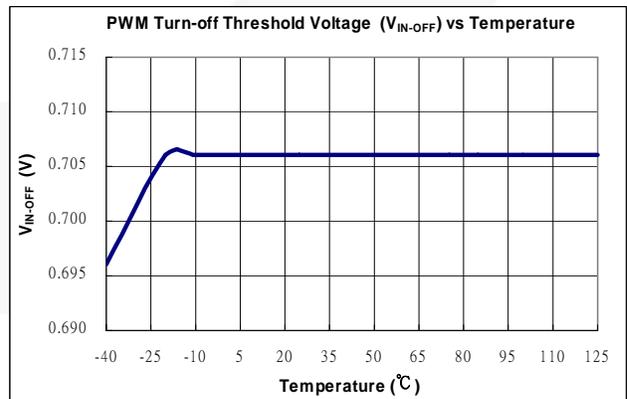


Figure 18. PWM Turn-off Threshold Voltage (V_{IN-OFF}) vs. Temperature

Operation Description

Startup Operation

The turn-on/turn-off thresholds are fixed internally at 16.5V and 10.5V. To enable the SG6846B during startup, the hold-up capacitor must first be charged to 16.5V through the startup resistor.

If an open-circuit or short-circuit to ground occurs at the RI pin, the internal protection circuit immediately shuts down the controller.

The hold-up capacitor continues to supply V_{DD} before energy can be delivered from the auxiliary winding of the main transformer. The V_{DD} must not drop below 10.5V during this startup process. This UVLO hysteresis window ensures that the hold-up capacitor can adequately supply V_{DD} during startup.

The typical startup current is only $8\mu\text{A}$, which allows a high-resistance, low-wattage startup resistor to be used. For constant output power limit over a universal input-voltage range, the peak-current threshold is adjusted by the voltage of the VIN pin. Since the VIN pin is connected to the rectified AC input line voltage through the resistive divider, a higher line voltage generates a higher V_{IN} voltage. The threshold voltage decreases as the V_{IN} increases, making the maximum output power at high line input voltage equal to that at low line input. The value of R-C network should not be so large it affects the power limit (shown in Figure 19). R and C should put on less than 300Ω and 1000pF , respectively, to minimize power loss. A $1.5\text{M}\Omega/0.25\text{W}$ startup resistor and a $10\mu\text{F}/25\text{V}$ V_{DD} hold-up capacitor are sufficient for a universal input range.

The required operating current has been reduced to 3.7mA, which enables higher efficiency and reduces the V_{DD} hold-up capacitance requirement.

Green-Mode Operation

The proprietary green-mode function provides off-time modulation to continuously decrease the switching frequency under light-load conditions. Maximum on-time is limited to provide protection against abnormal conditions. To further reduce power consumption under zero-load condition, the PWM oscillator is completely turned off and the power supply enters burst-mode. Green mode dramatically reduces power consumption under light-load and zero-load conditions. Power supplies using SG6846B can meet restrictive international regulations regarding standby power consumption.

Oscillator Operation

A resistor connected from the RI pin to GND generates an internal reference current source used to determine the PWM frequency. Increasing the resistance decreases the amplitude of the current source and reduces the PWM frequency. Using a $26\text{k}\Omega$ resistor results in a corresponding 65kHz switching frequency. The relationship between R_I and the switching frequency is:

$$f_{\text{PWM}}(\text{kHz}) = \frac{1690}{R_I (\text{k}\Omega)} \quad (2)$$

If an open-circuit or short-circuit to ground occurs at the RI pin, the internal protection circuit immediately shuts down the controller.

Two-level Over-current Protection (OCP)

The cycle-by-cycle current limiting shuts down the PWM immediately when the switching current is over the peak-current threshold. Additionally, when the switching current is higher than over-current threshold, the internal counter counts down. When the total accumulated counting time is more than $\sim 200\text{ms}$ ($R_I = 26\text{k}\Omega$), the controller is latched off and the internal counter counts up. When the switching current is lower than over-current threshold, the internal counter counts down. When the total accumulated counting time is more than $\sim 200\text{ms}$ ($R_I = 26\text{k}\Omega$), the controller is latched off.

This two-level OCP protection and up/down counter are especially designed for SMPS with surge current output, such as those for printers, scanners, and motor drivers.

Constant Output Power Limit

For constant output power limit over universal input-voltage range, the peak-current threshold is adjusted by the voltage of the VIN pin. Since the VIN pin is connected to the rectified AC input line voltage through the resistive divider, a higher line voltage generates a higher V_{IN} voltage. The threshold voltage decreases as V_{IN} increases, making the maximum output power at high-line input voltage equal to that at low-line input.

Brownout Protection

Since the VIN pin is connected through a resistive divider to the rectified AC input line voltage, it can also be used for brownout protection. If the V_{IN} voltage is less than 0.7V, the PWM output is shut off. If the V_{IN} is over 0.9V, the PWM output is turned on again. The hysteresis window for on/off is $\sim 0.2\text{V}$.

V_{DD} Over-voltage Protection (OVP)

V_{DD} over-voltage protection is built in to prevent damage. If V_{DD} is over 24V, SG6846B is latched off.

Over-Temperature Protection (OTP)

An external NTC thermistor can be connected from the RT pin to GND. The impedance of the NTC decreases at high temperatures. When the voltage of the RT pin drops below 1.05V, the SG6846B is turned off. For protection-mode options, see *Ordering Information*.

Operation Description (Continued)

Noise Immunity

Noise from the current sense or the control signal may cause significant pulse-width jitter, particularly in continuous-conduction mode. Slope compensation helps alleviate this problem. Good placement and layout practices should be followed. Avoid long PCB traces and component leads. Compensation and filter components should be located near the SG6846B.

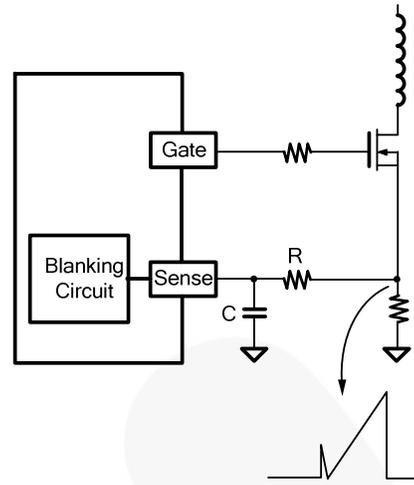


Figure 19. Current Sense R-C Filter

Reference Circuit

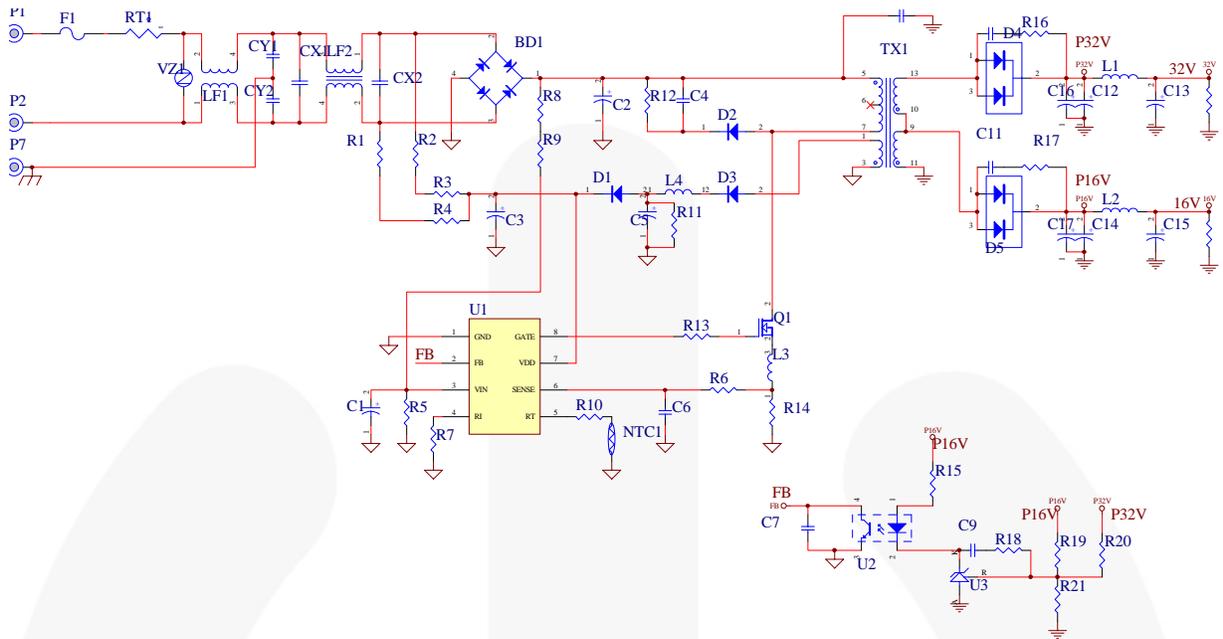


Figure 20. Application Circuit for 32V / 16V Output

BOM

| Part No. | Value | Part No. | Value | Part No. | Value |
|----------------|--------------|----------|---------------|----------|-----------------|
| R1, R2, R3, R4 | 470KΩ +/-5% | C4 | 103P 630V | D3 | FR103 1.0A 200V |
| R8, R9 | 51MΩ +/-1% | C10,C11 | 102P 1KV | BD1 | DBL406G |
| R5 | 16K2Ω +/-1% | C6,C7 | 102P 50V | D4 | BYT28-300 |
| R15 | 1K5Ω +/-5% | C9 | 222P 50V | D5 | BYV32-150 |
| R13 | 10Ω +/-5% | C14,C17 | 470μ 25V | F1 | 250V4A QUICK |
| R18 | 4K7Ω +/-5% | C15 | 220μ 25V | L1,L2 | 1.8μH |
| R21 | 15KΩ +/-1% | C13,C16 | 220μ 50V | L4 | 10μH |
| R7 | 27KΩ +/-5% | C2 | 150μ 400V | U3 | TL431 +/-1% |
| R6 | 330Ω +/-1% | C1 | 4.7μ 50V | U1 | SG6846 |
| R19 | 102KΩ +/-1% | C3 | 10μ 50V | U2 | PC817 |
| R14 | 0Ω22 +/-5% | CX1 | X1 0.47μ 275V | Q1 | 7NB60 |
| R16, R17 | 1W 20Ω +/-5% | C8 | Y2 222P 250V | TX1 | EI-33 |
| R11 | 20KΩ +/-5% | C5 | 100μ 50V | RT1 | SCK053 |
| R12 | 100KΩ +/-5% | CX2 | X2 0.1μF 275V | VZ1 | 14ψ 470V |
| R20 | 887KΩ +/-1% | D1 | 1N4148 | | |
| R22 | 10KΩ +/-1% | D2 | BYV95C | | |

Physical Dimensions

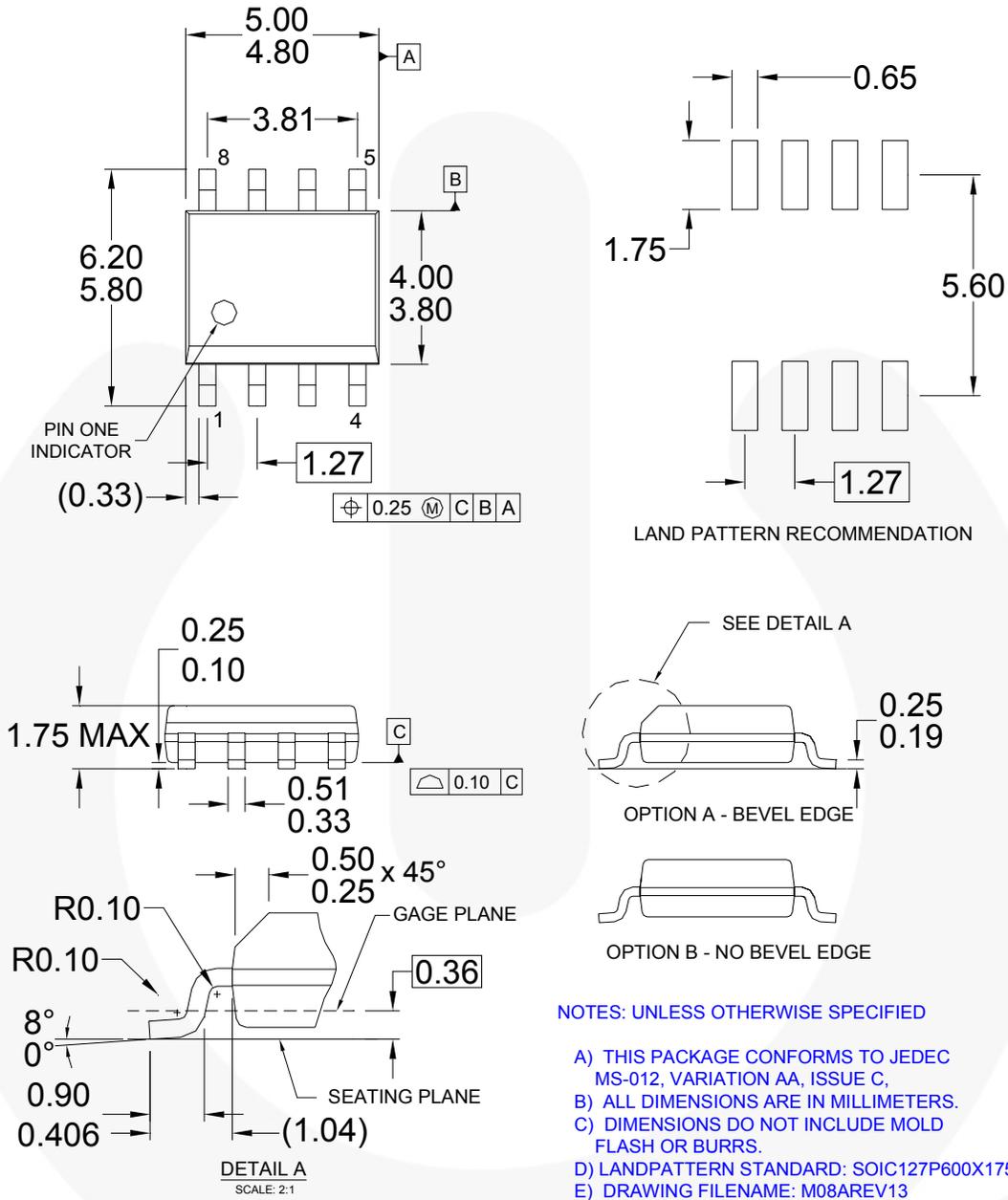


Figure 21. 8-Pin Small Outline Package (SOP)

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

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